LMV551,LMV552,LMV554

LMV551/LMV552/LMV554 3 MHz, Micropower RRO Amplifiers

TEXAS INSTRUMENTS

Literature Number: SNOSAQ5D

LMV551/LMV552/LMV554
3 MHz, Micropower RRO Amplifiers

General Description

The LMV551/LMV552/LMV554 are high performance, low power operational amplifiers implemented with National's advanced VIP50 process. They feature 3 MHz of bandwidth while consuming only 37 µA of current per amplifier, which is an exceptional bandwidth to power ratio in this op amp class. These amplifiers are unity gain stable and provide an excellent solution for low power applications requiring a wide bandwidth.

The LMV551/LMV552/LMV554 have a rail-to-rail output stage and an input common mode range that extends below ground.

The LMV551/LMV552/LMV554 have an operating supply voltage range from 2.7V to 5.5V. These amplifiers can operate over a wide temperature range (−40°C to 125°C) making them a great choice for automotive applications, sensor applications as well as portable instrumentation applications. The LMV551 is offered in the ultra tiny 5-Pin SC70 and 5-Pin SOT-23 package. The LMV552 is offered in an 8-Pin MSOP package. The LMV554 is offered in the 14-Pin TSSOP.

## Features

(Typical 5V supply, unless otherwise noted.)

- Guaranteed 3V and 5.0V performance
- High unity gain bandwidth   3 MHz
- Supply current (per amplifier)   37 µA
- CMRR   93 dB
- PSRR   90 dB
- Slew rate   1 V/µs
- Output swing with 100 kΩ load   70 mV from rail
- Total harmonic distortion   0.003% @ 1 kHz, 2 kΩ
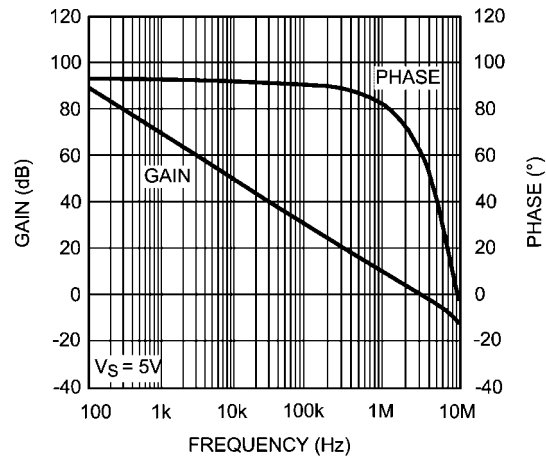- Temperature range   −40°C to 125°C

Applications

- Active filter
- Portable equipment
- Automotive
- Battery powered systems
- Sensors and Instrumentation

Typical Application
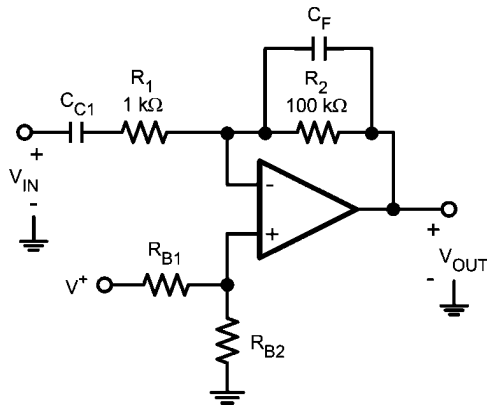
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Open Loop Gain and Phase vs. Frequency

Absolute Maximum Ratings (Note 1)

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/ Distributors for availability and specifications.

ESD Tolerance (Note 2)
  Human Body Model
    LMV551/LMV552/LMV554   2 KV
  Machine Model
    LMV551   100V
    LMV552/LMV554   250V
V_{IN} Differential (@ V^+ = 5V)   ±2.5V
Supply Voltage (V^+ - V^-)   6V
Voltage at Input/Output pins V^+ +0.3V, V^- −0.3V
Storage Temperature Range   −65°C to 150°C

Junction Temperature (Note 3)   150°C
Soldering Information
  Infrared or Convection (20 sec)   235°C
  Wave Soldering Lead Temp. (10 sec)   260°C

Operating Ratings (Note 1)

Temperature Range (Note 3)   −40°C to 125°C
Supply Voltage (V^+ – V^-)   2.7V to 5.5V
Package Thermal Resistance (θ_{JA} (Note 3))
  5-Pin SC70   456°C/W
  5-Pin SOT-23   234°C/W
  8-Pin MSOP   235°C/W
  14-Pin TSSOP   160°C/W

3V Electrical Characteristics

Unless otherwise specified, all limits are guaranteed for T_A = 25°C, V^+ = 3V, V^- = 0V, V_{CM} = V+/2 = V_O. **Boldface** limits apply at the temperature extremes. (Note 4)

Symbol	Parameter	Conditions		Min (Note 6)	Typ (Note 5)	Max (Note 6)	Units
V_{OS}	Input Offset Voltage				1	3 **4.5**	mV
TC V_{OS}	Input Offset Average Drift				3.3		µV/°C
I_B	Input Bias Current	(Note 7)			20	38	nA
I_{OS}	Input Offset Current				1	20	nA
CMRR	Common Mode Rejection Ratio	0V ≤ V_{CM} 2.0V		74 **72**	92		dB
PSRR	Power Supply Rejection Ratio	3.0 ≤ V^+ ≤ 5V, V_{CM} = 0.5V	LMV551/LMV552	80 **78**	92		dB
			LMV554	78 **76**			
		2.7 ≤ V^+ ≤ 5.5V, V_{CM} = 0.5V	LMV551/LMV552	80 **78**	92		
			LMV554	78 **76**			
CMVR	Input Common-Mode Voltage Range	CMRR ≥ 68 dB **CMRR ≥ 60 dB**		0 **0**		2.1 **2.1**	V
A_{VOL}	Large Signal Voltage Gain	0.4 ≤ V_O ≤ 2.6, R_L = 100 kΩ to V+/2	LMV551/LMV552	81 **78**	90		dB
			LMV554	79 **77**			
		0.4 ≤ V_O ≤ 2.6, R_L = 10 kΩ to V+/2		71 **68**	80		
V_O	Output Swing High	R_L = 100 kΩ to V+/2			40	48 **58**	mV from rail
		R_L = 10 kΩ to V+/2			85	100 **120**	
	Output Swing Low	R_L = 100 kΩ to V+/2			50	65 **77**	
		R_L = 10 kΩ to V+/2			95	110 **130**	
I_{SC}	Output Short Circuit Current	Sourcing (Note 9)			10		mA
		Sinking (Note 9)			25		

2

Symbol	Parameter	Conditions	Min (Note 6)	Typ (Note 5)	Max (Note 6)	Units
I_S	Supply Current per Amplifier			34	42 **52**	µA
SR	Slew Rate	$A_V = +1$, 10% to 90% (Note 8)		1		V/µs
Φm	Phase Margin	$R_L = 10$ kΩ, $C_L = 20$ pF		75		Deg
GBW	Gain Bandwidth Product			3		MHz
e_n	Input-Referred Voltage Noise	f = 100 kHz		70		nV/√Hz
		f = 1 kHz		70		
i_n	Input-Referred Current Noise	f = 100 kHz		0.1		pA/√Hz
		f = 1 kHz		0.15		
THD	Total Harmonic Distortion	$f = 1$ kHz, $A_V = 2$, $R_L = 2$ kΩ		0.003		%

5V Electrical Characteristics

Unless otherwise specified, all limits are guaranteed for $T_A = 25°C$, $V^+ = 5V$, $V^- = 0V$, $V_{CM} = V^+/2 = V_O$. **Boldface** limits apply at the temperature extremes.

Symbol	Parameter	Conditions	Min (Note 6)	Typ (Note 5)	Max (Note 6)	Units
V_{OS}	Input Offset Voltage			1	3.0 **4.5**	mV
TC V_{OS}	Input Offset Average Drift			3.3		µV/°C
I_B	Input Bias Current	(Note 7)		20	38	nA
I_{OS}	Input Offset Current			1	20	nA
CMRR	Common Mode Rejection Ratio	$0 \leq V_{CM} \leq 4.0V$	76 **74**	93		dB
PSRR	Power Supply Rejection Ratio	$3V \leq V^+ \leq 5V$ to $V_{CM} = 0.5V$	78 **75**	90		dB
		$2.7V \leq V^+ \leq 5.5V$ to $V_{CM} = 0.5V$	78 **75**	90		
CMVR	Input Common-Mode Voltage Range	CMRR ≥ 68 dB	0		4.1	V
		CMRR ≥ 60 dB	**0**		**4.1**	
A_{VOL}	Large Signal Voltage Gain	$0.4 \leq V_O \leq 4.6$, $R_L = 100$ kΩ to $V^+/2$	78 **75**	90		dB
		$0.4 \leq V_O \leq 4.6$, $R_L = 10$ kΩ to $V^+/2$	75 **72**	80		
V_O	Output Swing High	$R_L = 100$ kΩ to $V^+/2$		70	92 **122**	mV from rail
		$R_L = 10$ kΩ to $V^+/2$		125	155 **210**	
	Output Swing Low	$R_L = 100$ kΩ to $V^+/2$		60	70 **82**	
		$R_L = 10$ kΩ to $V^+/2$		110	130 **155**	
I_{SC}	Output Short Circuit Current	Sourcing (Note 9)		10		mA
		Sinking (Note 9)		25		
I_S	Supply Current Per Amplifier			37	46 **54**	µA
SR	Slew Rate	$A_V = +1$, $V_O = 1$ V_{PP} 10% to 90% (Note 8)		1		V/µs
Φm	Phase Margin	$R_L = 10$ kΩ, $C_L = 20$ pF		75		Deg
GBW	Gain Bandwidth Product			3		MHz

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Symbol	Parameter	Conditions	Min (Note 6)	Typ (Note 5)	Max (Note 6)	Units
e_n	Input-Referred Voltage Noise	f = 100 kHz		70		$nV/\sqrt{Hz}$
		f = 1 kHz		70		
i_n	Input-Referred Current Noise	f = 100 kHz		0.1		$pA/\sqrt{Hz}$
		f = 1 kHz		0.15		
THD	Total Harmonic Distortion	f = 1 kHz, A_V = 2, R_L = 2 kΩ		0.003		%

Note 1: Absolute Maximum Ratings indicate limits beyond which damage to the device may occur. Operating Ratings indicate conditions for which the device is intended to be functional, but specific performance is not guaranteed. For guaranteed specifications and the test conditions, see the Electrical Characteristics Tables.

Note 2: Human Body Model, applicable std. MIL-STD-883, Method 3015.7. Machine Model, applicable std. JESD22-A115-A (ESD MM std. of JEDEC) Field-Induced Charge-Device Model, applicable std. JESD22-C101-C (ESD FICDM std. of JEDEC).

Note 3: The maximum power dissipation is a function of $T_{J(MAX)}$, θ_{JA}. The maximum allowable power dissipation at any ambient temperature is $P_D = (T_{J(MAX)} - T_A)/ \theta_{JA}$. All numbers apply for packages soldered directly onto a PC board.

Note 4: Electrical Table values apply only for factory testing conditions at the temperature indicated. Factory testing conditions result in very limited self-heating of the device such that $T_J = T_A$. No guarantee of parametric performance is indicated in the electrical tables under conditions of internal self-heating where $T_J > T_A$.

Note 5: Typical values represent the most likely parametric norm as determined at the time of characterization. Actual typical values may vary over time and will also depend on the application and configuration. The typical values are not tested and are not guaranteed on shipped production material.

Note 6: Limits are 100% production tested at 25°C. Limits over the operating temperature range are guaranteed through correlations using statistical quality control (SQC) method.

Note 7: Positive current corresponds to current flowing into the device.

Note 8: Slew rate is the average of the rising and falling slew rates.

Note 9: The part is not short circuit protected and is not recommended for operation with heavy resistive loads.

Connection Diagrams

5-Pin SC70/ SOT-23

Top View

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8-Pin MSOP

Top View

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14-Pin TSSOP

Top View

20152610
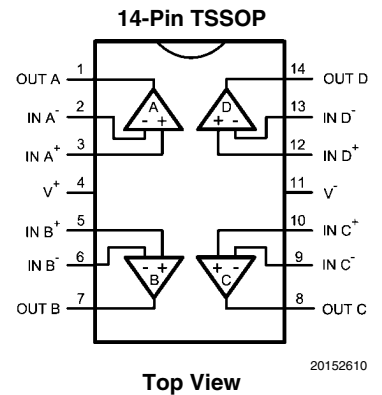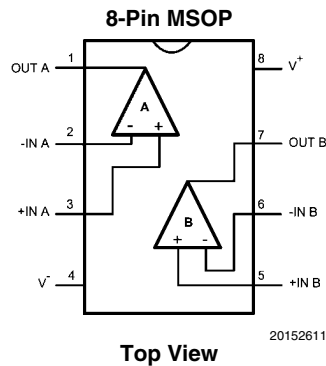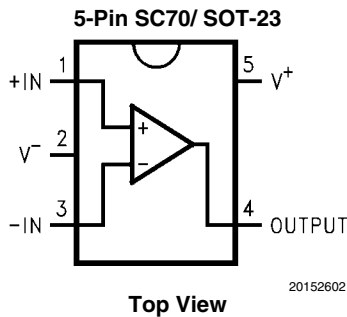
Ordering Information

| Package	Part Number	Package Marking	Transport Media	NSC Drawing
5-Pin SC70	LMV551MG	A94	1k Units Tape and Reel	MAA05A
	LMV551MGX		3k Units Tape and Reel	
5-Pin SOT-23	LMV551MF	AF3A	1k Units Tape and Reel	MF05A
	LMV551MFX		3k Units Tape and Reel	
8-Pin MSOP	LMV552MM	AH3A	1k Units Tape and Reel	MUA08A
	LMV552MMX		3.5k Units Tape and Reel	
14-Pin TSSOP	LMV554MT	LMV554MT	94 Units/Rail	MTC14
	LMV554MTX		2.5k Units Tape and Reel	

Typical Performance Characteristics

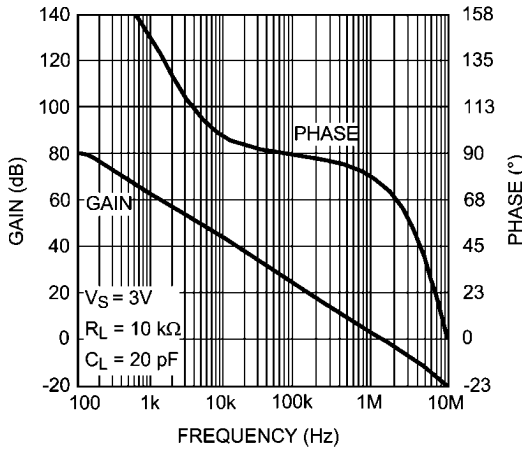**Open Loop Gain and Phase with Capacitive Load**
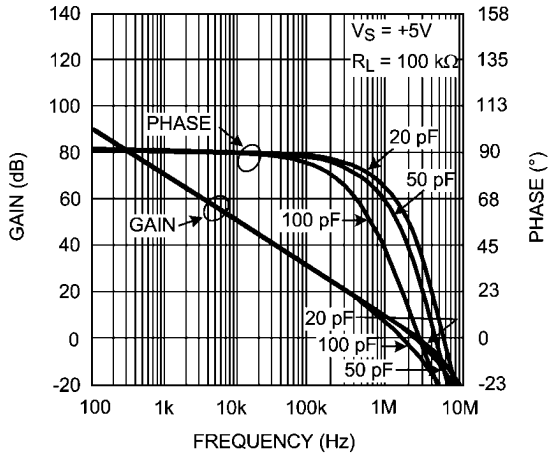
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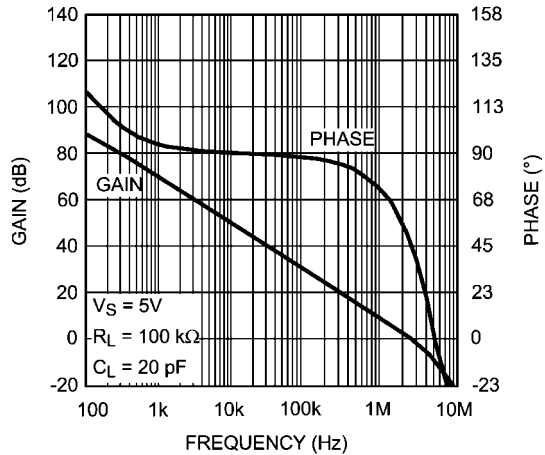**Open Loop Gain and Phase with Resistive Load**
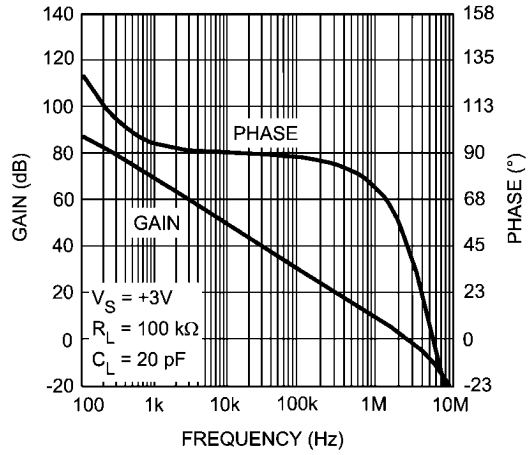
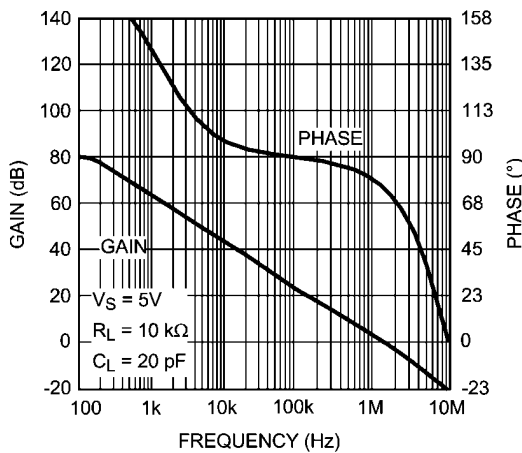20152615

Open Loop Gain and Phase with Resistive Load

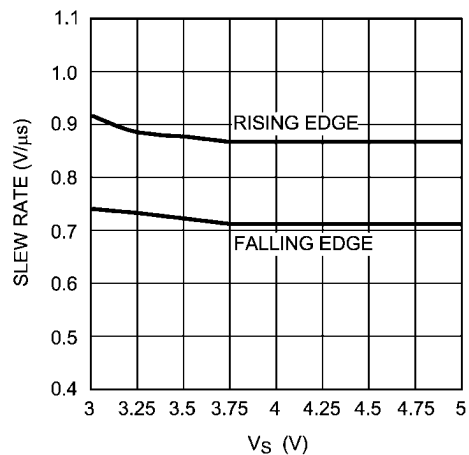20152616

Open Loop Gain and Phase with Resistive Load

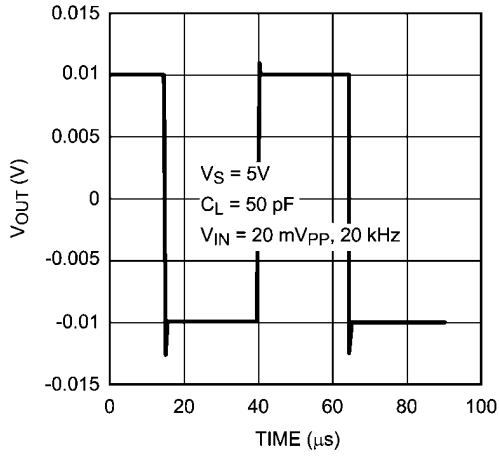
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Open Loop Gain and Phase with Resistive Load
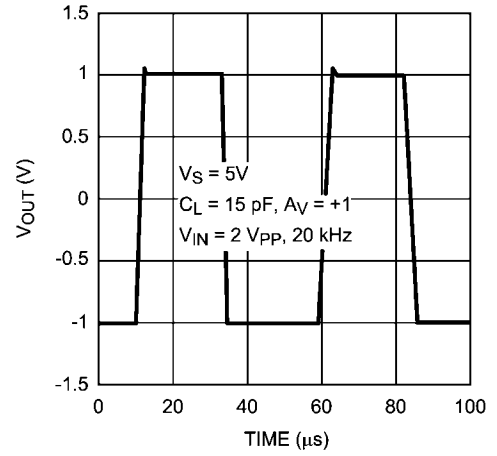

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Slew Rate vs. Supply voltage
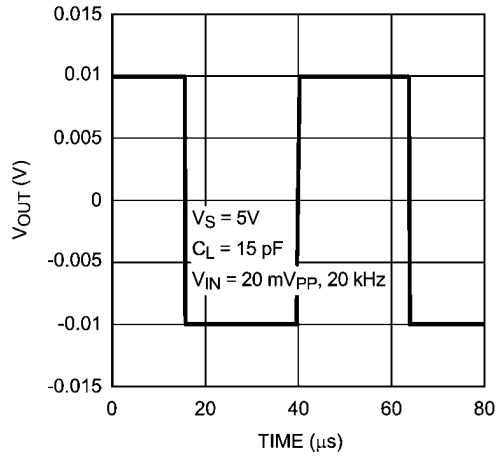

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Small Signal Transient Response

$V_S = 5V$
$C_L = 50$ pF
$V_{IN} = 20$ mV_{PP}, 20 kHz

TIME (μs)

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Large Signal Transient Response

$V_S = 5V$
$C_L = 15$ pF, $A_V = +1$
$V_{IN} = 2$ V_{PP}, 20 kHz

TIME (μs)

20152621

Small Signal Transient Response

$V_S = 5V$
$C_L = 15$ pF
$V_{IN} = 20$ mV_{PP}, 20 kHz

TIME (μs)

20152622

Input Referred Noise vs. Frequency

VOLTAGE nV/√Hz

CURRENT pA/√Hz

FREQUENCY (Hz)
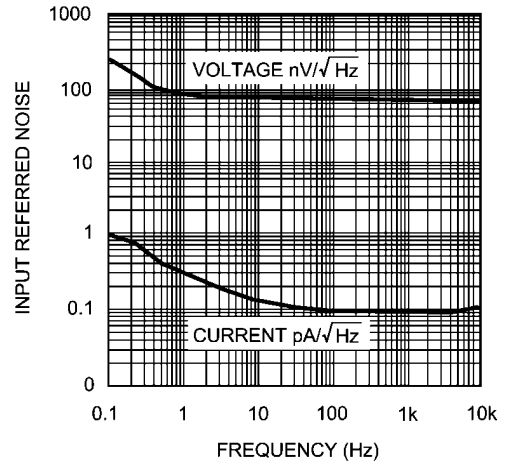
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THD+N vs. Amplitude @ 3V

$R_L = 10$ kΩ

$V_S = 3V$
$A_V = +2$
$V_{IN} = 1$ kHz SINE WAVE

$R_L = 100$ kΩ

V_{OUT} (V_{PP})
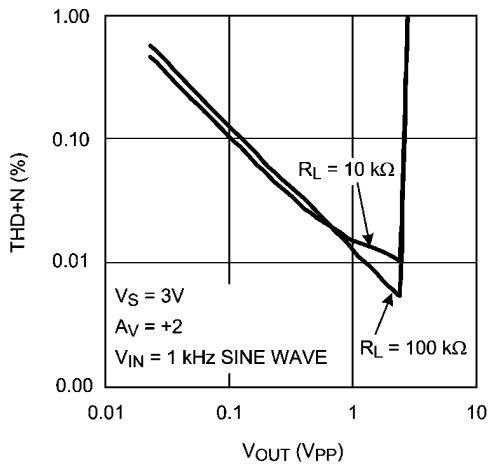
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THD+N vs. Amplitude @ 5V

$R_L = 10$ kΩ

$V_S = 5V$
$A_V = +2$
$V_{IN} = 1$ kHz SINE WAVE

$R_L = 100$ kΩ

V_{OUT} (V_{PP})

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THD+N vs. Amplitude

V$_S$ = 3V
A$_V$ = +2
V$_{OUT}$ = 1 V$_{PP}$

R$_L$ = 10 kΩ

R$_L$ = 100 kΩ

THD+N (%)

FREQUENCY (Hz)

20152626

THD+N vs. Amplitude

V$_S$ = 5V
A$_V$ = +2
V$_{OUT}$ = 2 V$_{PP}$

R$_L$ = 10 kΩ

R$_L$ = 100 kΩ

THD+N (%)

FREQUENCY (Hz)

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Supply Current vs. Supply Voltage

PER CHANNEL

125°C

25°C

-40°C

I$_S$ (µA)

V$_S$ (V)

20152628

V$_{OS}$ vs. V$_{CM}$

V$_S$ = 3V

-40°C

25°C

125°C

V$_{OS}$ (mV)

V$_{CM}$ (V)

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V$_{OS}$ vs. V$_{CM}$

V$_S$ = 5V

-40°C

25°C

125°C

V$_{OS}$ (mV)

V$_{CM}$ (V)

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V$_{OS}$ vs. Supply Voltage

-40°C

25°C

125°C

V$_{OS}$ (mV)

V$_S$ (V)

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LMV551/LMV552/LMV554

I_BIAS vs. V_CM

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I_BIAS vs. V_CM

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I_BIAS vs. Supply Voltage

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Positive Output Swing vs. Supply Voltage

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Negative Output Swing vs. Supply Voltage
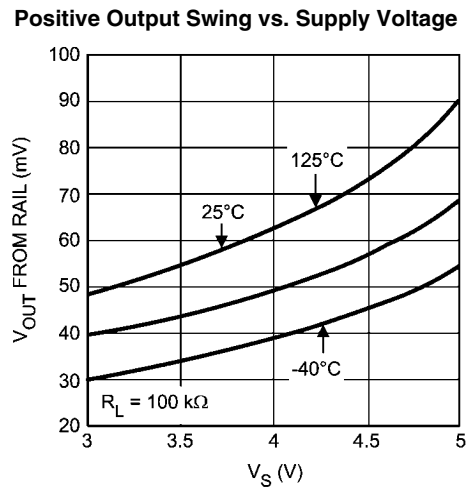

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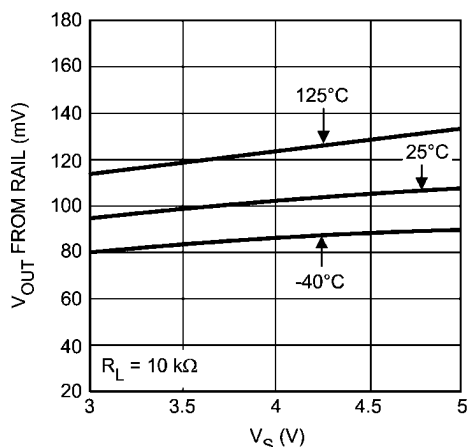**Positive Output Swing vs. Supply Voltage**

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Negative Output Swing vs. Supply Voltage

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Applications Information

ADVANTAGES OF THE LMV551/LMV552/LMV554

Low Voltage and Low Power Operation

The LMV551/LMV552/LMV554 have performance guaranteed at supply voltages of 3V and 5V and are guaranteed to be operational at all supply voltages between 2.7V and 5.5V. For this supply voltage range, the LMV551/LMV552/LMV554 draw the extremely low supply current of less than 37 μA per amp.

Wide Bandwidth

The bandwidth to power ratio of 3 MHz to 37 μA per amplifier is one of the best bandwidth to power ratios ever achieved. This makes these devices ideal for low power signal processing applications such as portable media players and instrumentation.

Low Input Referred Noise

The LMV551/LMV552/LMV554 provide a flatband input referred voltage noise density of 70 nV/$\sqrt{\text{Hz}}$, which is significantly better than the noise performance expected from an ultra low power op amp. They also feature the exceptionally low 1/f noise corner frequency of 4 Hz. This noise specification makes the LMV551/LMV552/LMV554 ideal for low power applications such as PDAs and portable sensors.

Ground Sensing and Rail-to-Rail Output

The LMV551/LMV552/LMV554 each have a rail-to-rail output stage, which provides the maximum possible output dynamic range. This is especially important for applications requiring a large output swing. The input common mode range includes the negative supply rail which allows direct sensing at ground in a single supply operation.

Small Size

The small footprints of the LMV551/LMV552/LMV554 packages save space on printed circuit boards, and enable the design of smaller and more compact electronic products. Long traces between the signal source and the op amp make the signal path susceptible to noise. By using a physically smaller package, the amplifiers can be placed closer to the signal source, reducing noise pickup and enhancing signal integrity

STABILITY OF OP AMP CIRCUITS

Stability and Capacitive Loading

As seen in the Phase Margin vs. Capacitive Load graph, the phase margin reduces significantly for C_L greater than 100 pF. This is because the op amp is designed to provide the maximum bandwidth possible for a low supply current. Stabilizing them for higher capacitive loads would have required either a drastic increase in supply current, or a large internal compensation capacitance, which would have reduced the bandwidth of the op amp. Hence, if the LMV551/LMV552/LMV554 are to be used for driving higher capacitive loads, they will have to be externally compensated.
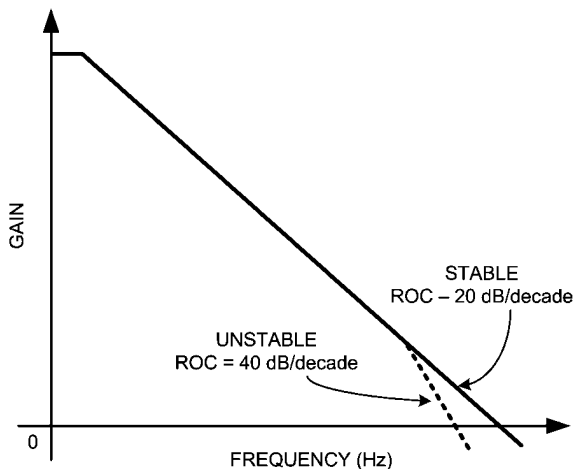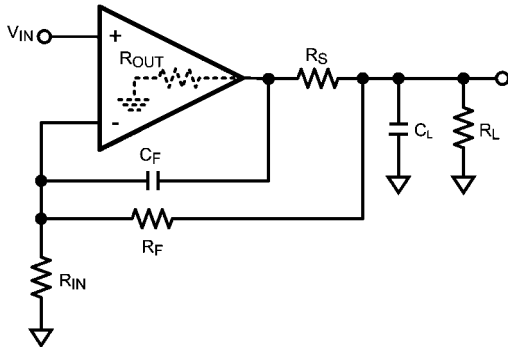

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FIGURE 1. Gain vs. Frequency for an Op Amp

An op amp, ideally, has a dominant pole close to DC, which causes its gain to decay at the rate of 20 dB/decade with respect to frequency. If this rate of decay, also known as the rate of closure (ROC), remains the same until the op amp's unity gain bandwidth, the op amp is stable. If, however, a large capacitance is added to the output of the op amp, it combines with the output impedance of the op amp to create another pole in its frequency response before its unity gain frequency (*Figure 1*). This increases the ROC to 40 dB/ decade and causes instability.

In such a case a number of techniques can be used to restore stability to the circuit. The idea behind all these schemes is to modify the frequency response such that it can be restored to an ROC of 20 dB/decade, which ensures stability.

In the Loop Compensation

Figure 2 illustrates a compensation technique, known as 'in the loop' compensation, that employs an RC feedback circuit within the feedback loop to stabilize a non-inverting amplifier configuration. A small series resistance, R_S, is used to isolate the amplifier output from the load capacitance, C_L, and a small capacitance, C_F, is inserted across the feedback resistor to bypass C_L at higher frequencies.

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FIGURE 2. In the Loop Compensation

The values for R_S and C_F are decided by ensuring that the zero attributed to C_F lies at the same frequency as the pole attributed to C_L. This ensures that the effect of the second pole on the transfer function is compensated for by the presence of the zero, and that the ROC is maintained at 20 dB/decade. For the circuit shown in *Figure 2* the values of R_S and C_F are given by *Equation 1*. Values of R_S and C_F required for maintaining stability for different values of C_L, as well as the phase margins obtained, are shown in *Table 1*. R_F, R_{IN}, and R_L are to be 10 kΩ, while R_{OUT} is 340Ω.

$$R_S = \frac{R_{OUT}R_{IN}}{R_F}$$

$$C_F = \left(1 + \frac{1}{A_{CL}}\right)\left(\frac{R_F + 2R_{IN}}{R_F^2}\right)C_L R_{OUT} \tag{1}$$

TABLE 1.

C_L (pF)	R_S (Ω)	C_F (pF)	Phase Margin (°)
50	340	8	47
100	340	15	42
150	340	22	40

Although this methodology provides circuit stability for any load capacitance, it does so at the price of bandwidth. The closed loop bandwidth of the circuit is now limited by R_F and C_F.

Compensation by External Resistor

In some applications it is essential to drive a capacitive load without sacrificing bandwidth. In such a case, in the loop compensation is not viable. A simpler scheme for compensation

is shown in *Figure 3*. A resistor, R_{ISO}, is placed in series between the load capacitance and the output. This introduces a zero in the circuit transfer function, which counteracts the effect of the pole formed by the load capacitance and ensures stability. The value of R_{ISO} to be used should be decided depending on the size of C_L and the level of performance desired. Values ranging from 5Ω to 50Ω are usually sufficient to ensure stability. A larger value of R_{ISO} will result in a system with less ringing and overshoot, but will also limit the output swing and the short circuit current of the circuit.
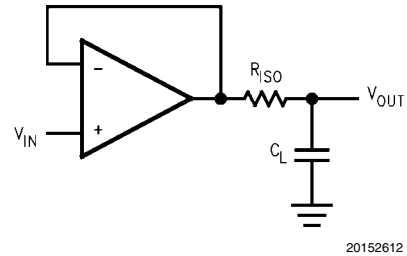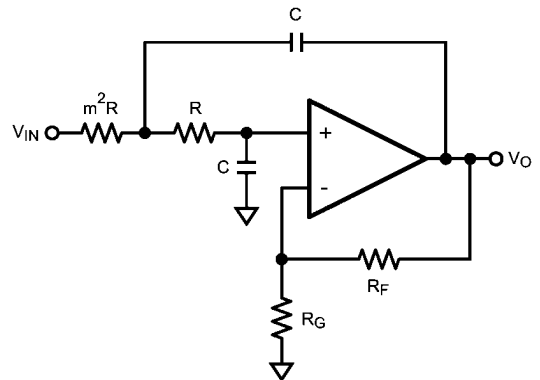

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FIGURE 3. Compensation by Isolation Resistor

Typical Application

ACTIVE FILTERS

With a wide unity gain bandwidth of 3 MHz, low input referred noise density and a low power supply current, the LMV551/LMV552/LMV554 are well suited for low-power filtering applications. Active filter topologies, such as the Sallen-Key low pass filter shown in *Figure 4*, are very versatile, and can be used to design a wide variety of filters (Chebyshev, Butterworth or Bessel). The Sallen-Key topology, in particular, can be used to attain a wide range of Q, by using positive feedback to reject the undesired frequency range.

In the circuit shown in *Figure 4*, the two capacitors appear as open circuits at lower frequencies and the signal is simply buffered to the output. At high frequencies the capacitors appear as short circuits and the signal is shunted to ground by one of the capacitors before it can be amplified. Near the cutoff frequency, where the impedance of the capacitances is on the same order as R_G and R_F, positive feedback through the other capacitor allows the circuit to attain the desired Q.
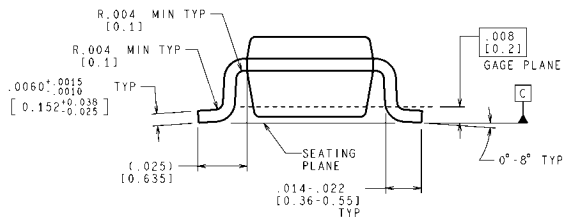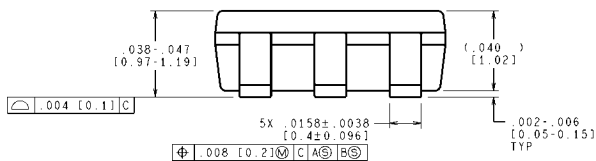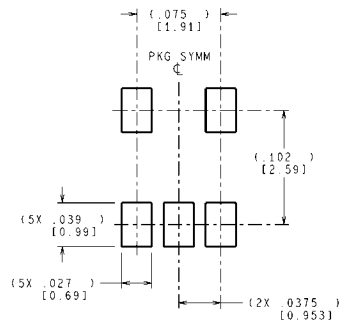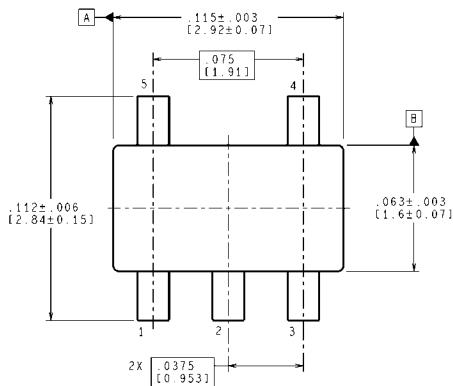

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FIGURE 4. Sallen-Key Filter
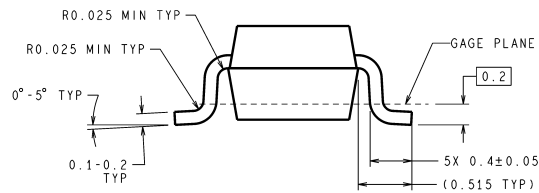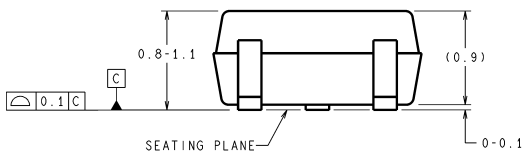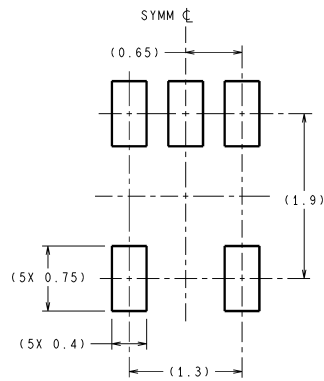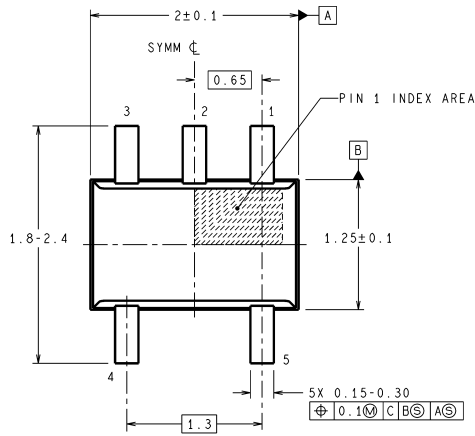
5-Pin SC70
NS Package Number MAA05A

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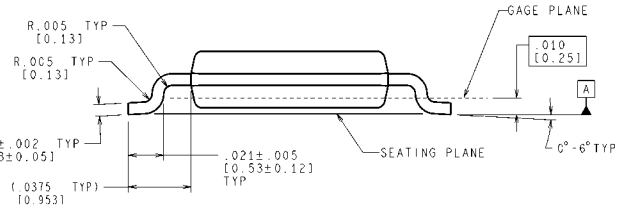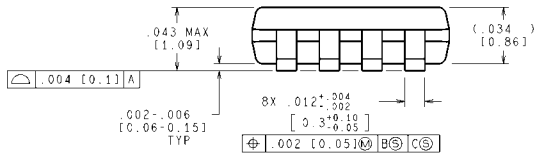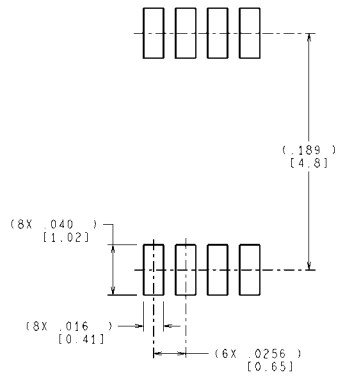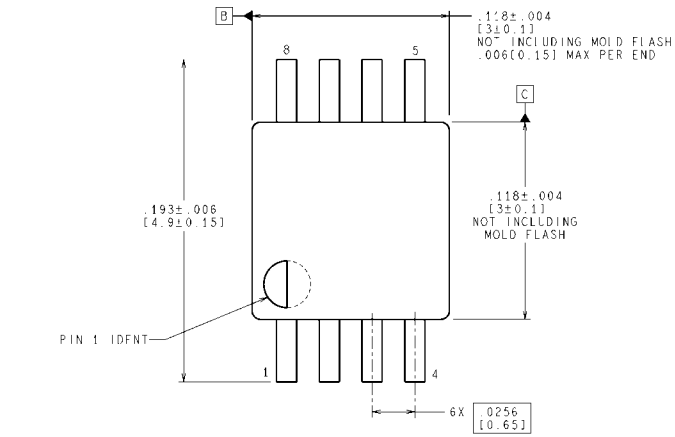
MAA05A (Rev D)

LAND PATTERN RECOMMENDATION

5-Pin SOT-23
NS Package Number MF05A

CONTROLLING DIMENSION IS INCH
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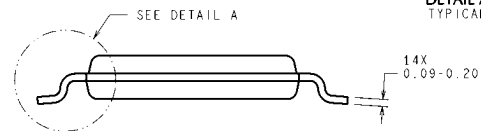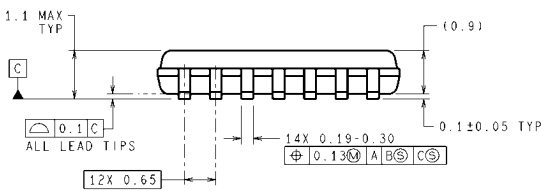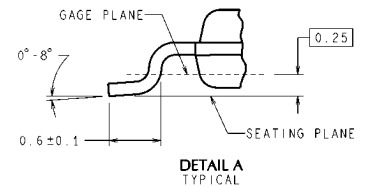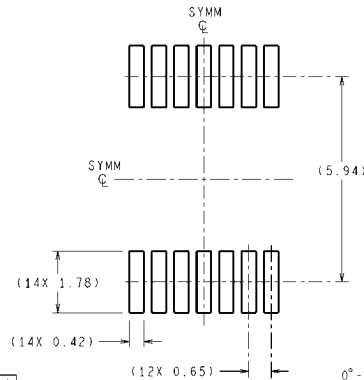DIMENSIONS IN ( ) FOR REFERENCE ONLY

MF05A (Rev D)

LAND PATTERN RECOMMENDATION

.118±.004
[3±0.1]
NOT INCLUDING MOLD FLASH
.006[0.15] MAX PER END

.193±.006
[4.9±0.15]

.118±.004
[3±0.1]
NOT INCLUDING
MOLD FLASH

PIN 1 IDENT

(.189)
[4.8]

(8X .040)
[1.02]

(8X .016)
[0.41]

(6X .0256)
[0.65]

6X .0256
[0.65]

RECOMMENDED LAND PATTERN

.043 MAX
[1.09]

(.034)
[0.86]

.004 [0.1] A

.002-.006
[0.06-0.15]
TYP

8X .012 +.004
-.002
[0.3 +0.10
-0.05]

.002 [0.05] M B S C S

R.005 TYP
[0.13]

R.005 TYP
[0.13]

.007±.002 TYP
[0.18±0.05]

(.0375 TYP)
[0.953]

.021±.005
[0.53±0.12]
TYP

GAGE PLANE

.010
[0.25]

SEATING PLANE

0°-6° TYP

CONTROLLING DIMENSION IS INCH
VALUES IN [ ] ARE MILLIMETERS

MUA08A (Rev F)

8-Pin MSOP
NS Package Number MUA08A

5±0.1

6.4

3.2

4.4±0.1

PIN #1 ID

0.2 C B A
ALL LEAD TIPS

SYMM
CL

SYMM
CL

(14X 1.78)

(14X 0.42)

(12X 0.65)

(5.94)

RECOMMENDED LAND PATTERN

GAGE PLANE

0°-8°

0.6±0.1

0.25

SEATING PLANE

DETAIL A
TYPICAL

1.1 MAX
TYP

C

0.1 C
ALL LEAD TIPS

12X 0.65

14X 0.19-0.30

0.13 M A B S C S

(0.9)

0.1±0.05 TYP

SEE DETAIL A

14X
0.09-0.20

DIMENSIONS ARE IN MILLIMETERS
DIMENSIONS IN ( ) FOR REFERENCE ONLY
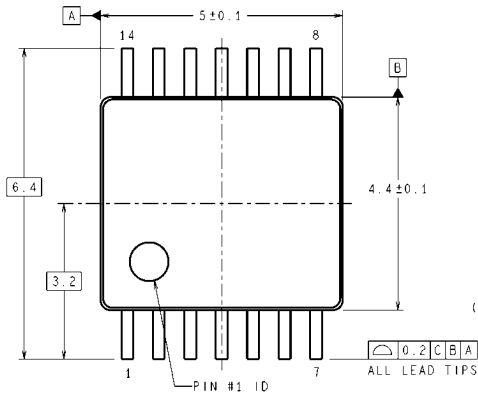
MTC14 (Rev D)

14-Pin TSSOP
NS Package Number MTC14

Notes

Notes

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Displays	www.national.com/displays	Green Compliance	www.national.com/quality/green
Ethernet	www.national.com/ethernet	Packaging	www.national.com/packaging
Interface	www.national.com/interface	Quality and Reliability	www.national.com/quality
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LDOs	www.national.com/ldo		
LED Lighting	www.national.com/led		
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